Power MOSFET for 1-Cell Lithium-ion Battery Protection 12V, 9.0mΩ, 13A, Dual N-Channel



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This Power MOSFET features a low on-state resistance. This device is suitable for applications such as power switches of portable machines. Best suited for 1-cell lithium-ion battery applications.

Features

- 2.5V drive
- 2kV ESD HBM
- Common-Drain Type
- ESD Diode-Protected Gate
- Pb-Free, Halogen Free and RoHS compliance

Applications

• 1-Cell Lithium-ion Battery Charging and Discharging Switch

SPECIFICATIONS

ABSOLUTE MAXIMUM RATINGS at Ta = 25°C (Note 1)

Parameter	Symbol	Value	Unit
Source to Source Voltage	VSSS	12	V
Gate to Source Voltage	VGSS	±12	V
Source Current (DC)	Is	13	Α
Source Current (Pulse) PW≤10µs, duty cycle≤1%	ISP	60	Α
Total Dissipation Surface mounted on ceramic substrate (5000mm² × 0.8mm)	PT	1.6	W
Junction Temperature	Tj	150	°C
Storage Temperature	Tstg	_55 to +150	°C

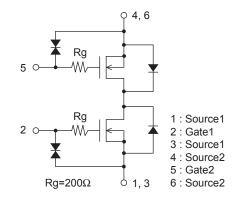
Note 1: Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE RATINGS			
Parameter	Symbol	Value	Unit
Junction to Ambient Surface mounted on ceramic substrate (5000mm² × 0.8mm)	R _θ ЈА	78.1	°C/W

Vsss	Rss(on) Max	IS Max
	9.0mΩ@ 4.5V	
	9.7mΩ@ 4.0V	
12V	10.0mΩ@ 3.8V	13A
	12.7mΩ@ 3.1V	
	17.7mΩ@ 2.5V	

ELECTRICAL CONNECTION N-Channel



MARKING





ORDERING INFORMATION

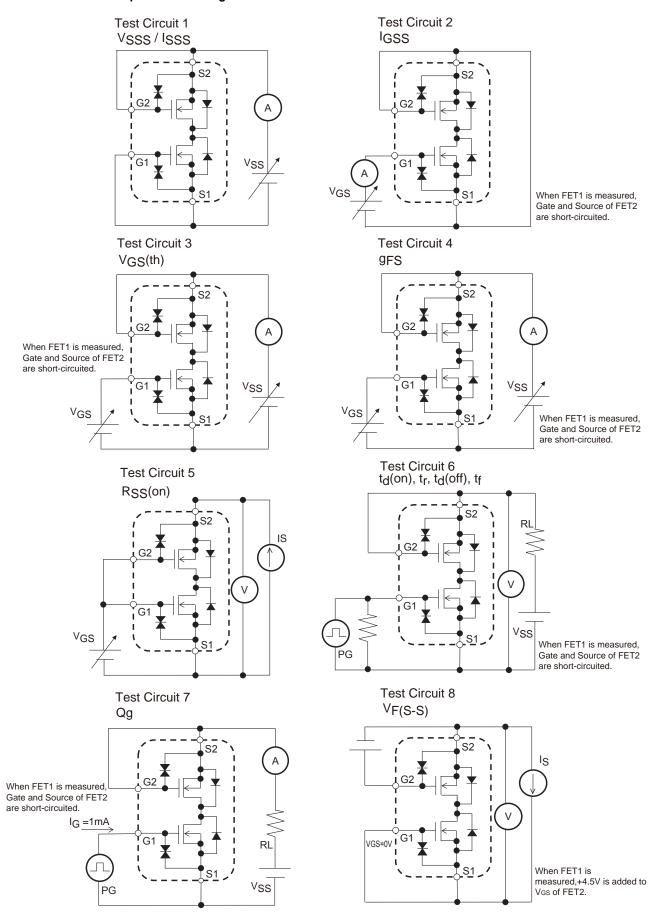
See detailed ordering and shipping information on page 6 of this data sheet.

ELECTRICAL CHARACTERISTICS at Ta = 25°C (Note 2)

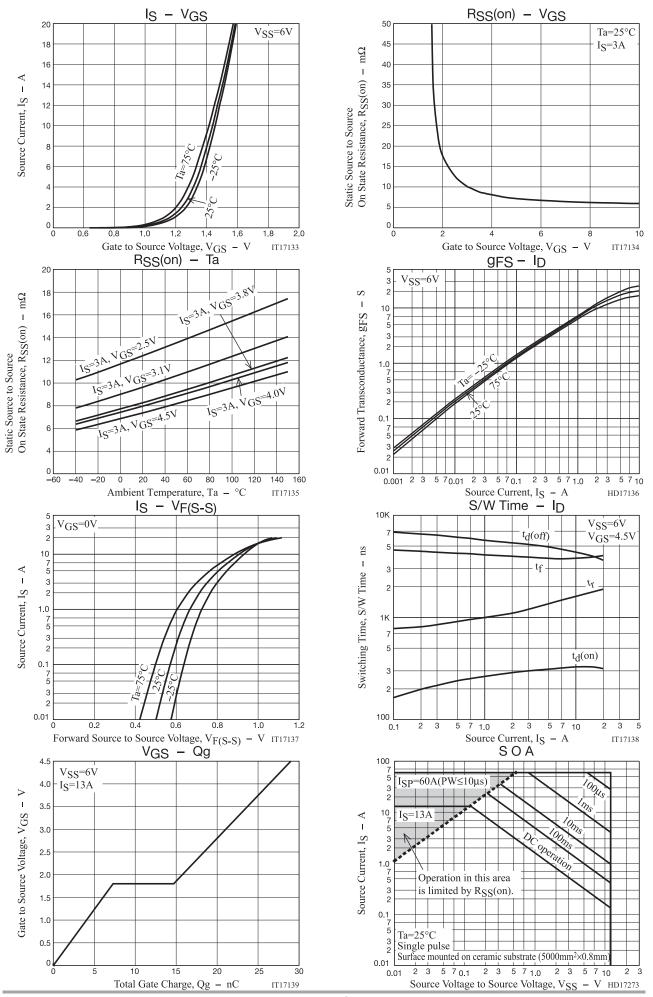
Davanatas	Currento ed	Conditions		Ratings			
Parameter	Symbol			min	typ	max	Unit
Source to Source Breakdown Voltage	V(BR)SSS	IS=1mA, VGS=0V	Test Circuit 1	12			٧
Zero-Gate Voltage Source Current	ISSS	V _{SS} =10V, V _{GS} =0V	Test Circuit 1			1	μА
Gate to Source Leakage Current	IGSS	VGS=±8V, VSS=0V	Test Circuit 2			±1.0	μА
Gate Threshold Voltage	VGS(th)	VSS=6V, IS=1mA	Test Circuit 3	0.5		1.3	V
Forward Transconductance	gFS	VSS=6V, IS=3A	Test Circuit 4		13.7		S
	Rss(on)1	IS=3A, VGS=4.5V	Test Circuit 5	6.0	7.5	9.0	mΩ
	Rss(on)2	IS=3A, VGS=4.0V	Test Circuit 5	6.4	8.1	9.7	mΩ
Static Source to Source On-State Resistance	Rss(on)3	IS=3A, VGS=3.8V	Test Circuit 5	6.7	8.4	10.0	mΩ
Resistance	Rss(on)4	IS=3A, VGS=3.1V	Test Circuit 5	7.8	9.8	12.7	mΩ
	Rss(on)5	IS=3A, VGS=2.5V	Test Circuit 5	10.0	12.6	17.7	mΩ
Turn-ON Delay Time	t _d (on)				300		ns
Rise Time	tr	VSS=6V, VGS=4.5V, IS=3A Test Circuit 6			1200		ns
Turn-OFF Delay Time	t _d (off)				5200		ns
Fall Time	tf	1			3900		ns
Total Gate Charge	Qg	V _S S=6V, V _G S=4.5V, I _S =13A Test Circuit 7			29		nC
Forward Source to Source Voltage	VF(S-S)	IS=3A, VGS=0V	Test Circuit 8		0.75	1.2	V

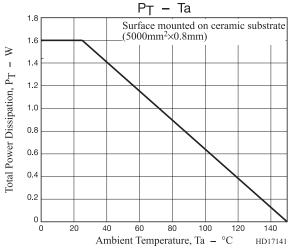
Note 2 : Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

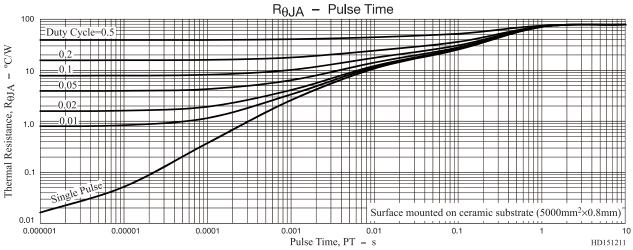
Test circuits are example of measuring FET1 side



When FET2 is measured, the position of FET1 and FET2 is switched.





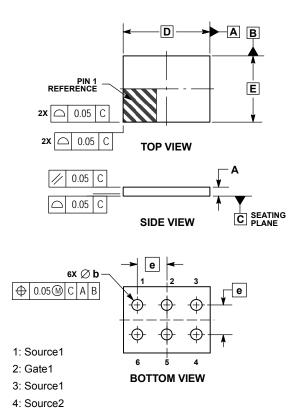


PACKAGE DIMENSIONS

unit: mm

WLCSP6 1.91x1.46 / EFCP1915-6CE-020

CASE 614AC **ISSUE B**

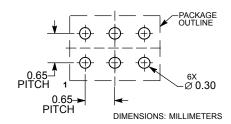


NOTES:

- DIMENSIONING AND TOLERANCING PER
- ASME Y14.5M, 1994.
 2. CONTROLLING DIMENSION: MILLIMETERS.

MILLIMETERS		
MIN	MAX	
0.18	0.22	
0.27	0.33	
1.91	BSC	
1.46 BSC		
0.65	BSC	
	0.18 0.27 1.91 1.46	

RECOMMENDED SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

ORDERING INFORMATION

5: Gate2 6: Source2

Device	Marking	Package	Shipping (Qty / Packing)
EFC6604R-TR	MD	WLCSP6 1.91x1.46 / EFCP1915-6CE-020 (Pb-Free / Halogen Free)	5,000 / Tape & Reel

[†] For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D. http://www.onsemi.com/pub_link/Collateral/BRD8011-D.PDF

Note on usage: Since the EFC6604R is a MOSFET product, please avoid using this device in the vicinity of highly charged objects. Please contact sales for use except the designated application.

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